

# MGFC40V7785B

**PRELIMINARY**

Notice: This is not a final specification.  
Some parametric limits are subject to change.

## 7.7~8.5GHz BAND 10W INTERNALLY MATCHED GaAs FET

### DESCRIPTION

The MGFC40V7785B is an internally impedance-matched GaAs power FET especially designed for use in 7.7~8.5 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

### FEATURES

- Class A operation
- Internally matched to 50Ω system
- High output power  
P<sub>1dB</sub> = 10W (TYP) @ 7.7~8.5 GHz
- High power gain  
G<sub>LP</sub> = 8 dB (TYP) @ 7.7~8.5GHz
- High power added efficiency  
η<sub>add</sub> = 26% (TYP) @ 7.7~8.5GHz, P<sub>1dB</sub>
- Hermetically sealed metal-ceramic package
- Low distortion [Item: -51]  
IM<sub>3</sub> = -45 dBc (TYP) @ P<sub>o</sub> = 28 (dBm) S.C.L.
- Low thermal resistance R<sub>th(ch-c)</sub> ≤ 2.8°C/W

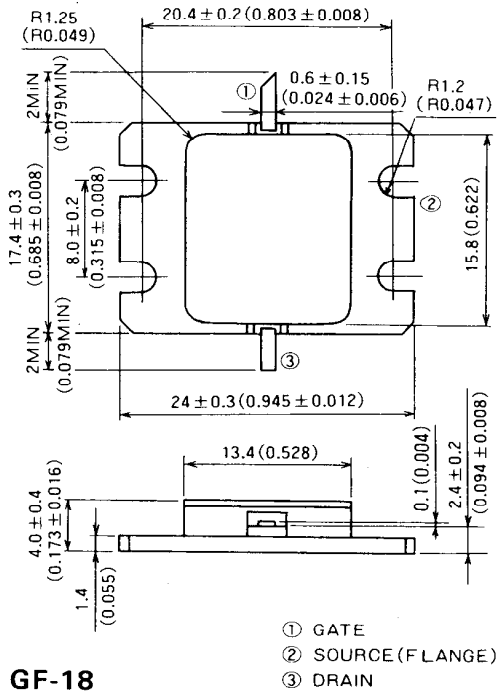
### APPLICATION

- Item-01: 7.7~8.5GHz band power amplifier
- Item-51: Digital radio communication

### QUALITY GRADE

- IG

### OUTLINE DRAWING Unit: millimeters (inches)



### ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub> = 25°C)

Symbol	Parameter	Ratings	Unit
V <sub>GD0</sub>	Gate to drain voltage	-15	V
V <sub>GSO</sub>	Gate to source voltage	-15	V
I <sub>D</sub>	Drain current	6	A
I <sub>GR</sub>	Reverse gate current	-20	mA
I <sub>GF</sub>	Forward gate current	42	mA
P <sub>T</sub>	Total power dissipation *1	53.5	W
T <sub>ch</sub>	Channel temperature	175	°C
T <sub>stg</sub>	Storage temperature	-65 ~ +175	°C

\*1: T<sub>c</sub> = 25°C

### RECOMMENDED BIAS CONDITIONS

- V<sub>DS</sub> = 10V
- I<sub>D</sub> = 2.4A
- R<sub>g</sub> = 50Ω
- Refer to Bias Procedure

### ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
I <sub>DSS</sub>	Saturated drain current	V <sub>DS</sub> = 3V, V <sub>GS</sub> = 0V	—	4.5	6	A
g <sub>m</sub>	Transconductance	V <sub>DS</sub> = 3V, I <sub>D</sub> = 2.2A	—	2	—	S
V <sub>GS(off)</sub>	Gate to source cut-off voltage	V <sub>DS</sub> = 3V, I <sub>D</sub> = 40mA	—	-3	-4.5	V
P <sub>1dB</sub>	Output power at 1dB gain compression	V <sub>DS</sub> = 10V, I <sub>D</sub> = 2.4A, f = 7.7~8.5GHz	38.0	40.0	—	dBm
G <sub>LP</sub>	Linear power gain		7	8	—	dB
I <sub>D</sub>	Drain current		—	3.0	—	A
η <sub>add</sub>	Power added efficiency		—	26	—	%
IM <sub>3</sub>	3rd order IM distortion *1		-42	-45	—	dBc
R <sub>th(ch-o)</sub>	Thermal resistance *2		ΔV <sub>f</sub> method	—	—	2.8

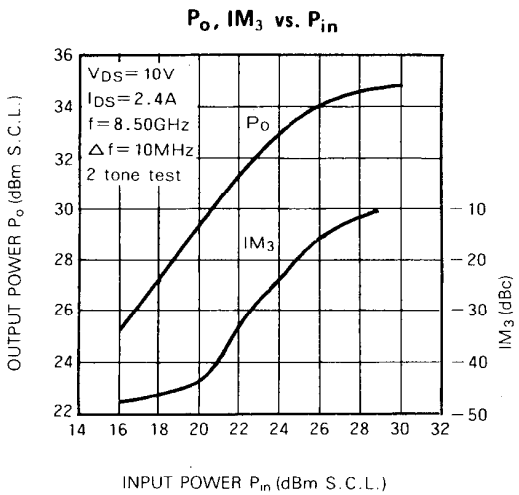
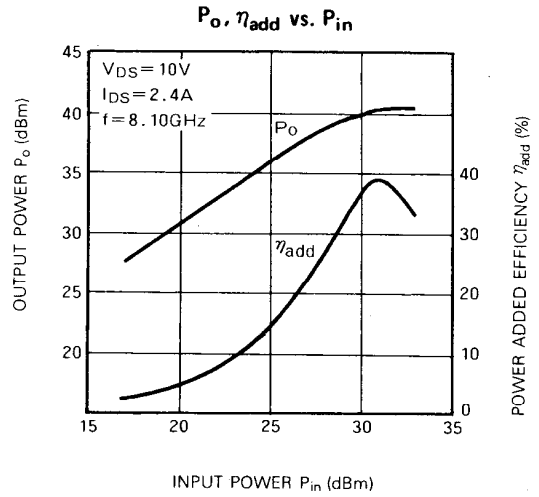
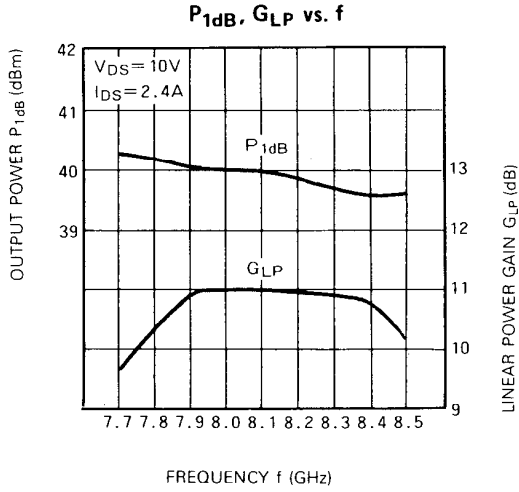
\*1: Item-51, 2-tone test P<sub>o</sub> = 28 dBm Single Carrier Level f = 8.5GHz Δf = 10 MHz. \*2: Channel to case

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**TYPICAL CHARACTERISTICS (Ta=25°C)**



**S PARAMETERS (Ta=25°C, VDS=10V, IDS=2.4A)**

f (GHz)	S Parameters (TYP.)							
	$S_{11}$		$S_{21}$		$S_{12}$		$S_{22}$	
	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)
7.7	0.63	9	3.03	155	0.103	96	0.37	-23
7.8	0.63	-5	3.81	142	0.107	84	0.35	-33
7.9	0.61	-17	3.11	129	0.109	70	0.32	-42
8.0	0.59	-33	3.20	115	0.115	56	0.26	-53
8.1	0.54	-50	3.33	99	0.115	42	0.21	-69
8.2	0.49	-72	3.41	84	0.125	29	0.16	-89
8.3	0.43	-99	3.49	66	0.129	11	0.09	-131
8.4	0.39	-136	3.48	48	0.130	-8	0.10	139
8.5	0.41	-176	3.33	58	0.126	-26	0.21	103